

**EXPEDITED PROCEDURE – EXAMINING GROUP 3729**

**S/N 10/628,594**

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Robert C. Sundahl et al. Examiner: Donghai Nguyen  
Serial No.: 10/628,594 Group Art Unit: 3729  
Filed: July 28, 2003 Docket No.: 884.264US2  
Title: METHOD FOR MANUFACTURING AN INTERCONNECTED CIRCUIT  
BOARD ASSEMBLY AND SYSTEM  
Assignee: Intel Corporation Customer Number: 21186

**SUPPLEMENTAL AMENDMENT AND RESPONSE UNDER 37 C.F.R. 1.116**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

In response to the Final Office Action mailed June 22, 2006 and the Advisory Action  
mailed September 26, 2006. please amend the application as follows:

OK 10/31/06

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